

4 3 2 1

PART NO.	SEE TABLE
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REVISIONS			
LTR	DESCRIPTION	Drawing	DATE
A	RELEASE NEW PRODUCT	GARY	09/21/07

CUSTOMER DRAWING

剖面圖 A-A

RECOMMENDED PCB LAYOUT

NOTE:

- MATERIAL :
 BASE : HIGH TEMPERATURE THERMOPLASTIC UL94V-0,
 TERMINAL: COPPER ALLOY, THICKNESS = 0.30 mm
 FORK LOCK: COPPER ALLOY, THICKNESS = 0.30 mm
- PLATING:
 CONTACT: GOLD OVER 50u" MIN NICKEL UNDERPLATE
 SOLDER TAIL: 150u" MIN MISTY TIN 50u" MIN NICKEL UNDERPLATE
 GOLD SPECIFICATION: SEE TABLE
- ELECTRONICAL SPECIFICATION:
 CURRENT RATING: 1.5 AMPERE PER CONTACT
 CONTACT RESISTANCE: 30 MILLIOHMS MAX.
 INSULATION RESISTANCE: 1000 MEGOHMS MIN.
 DIELECTRIC WITHSTANDING VOLTAGE: 500 VDC.
 OPERATING TEMPERATURE: -40°C ~ +85°C
- MEETS THE REQUIREMENTS OF DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL OF 27 JANUARY 2003 ON THE RESTRICTION OF THE USE OF CERTAIN HAZARDOUS SUBSTANCES IN ELECTRICAL AND ELECTRONIC EQUIPMENT (ROHS)

TABLE

007-01-00498	15 U" GOLD	LCP_BLACK
PART NO.	PLATED	PLASTIC&COLOR

DIMENSION ARE MILLIMETERS TOLERANCES ARE : DECIMALS .X ± 0.20 .XX ± 0.15 ANGLE: X ± 3°	APPROVALS		DATE	TITLE: SATA 22P SOCKET 加高塑柱型
	DRAWN	GARY	09/21/07	
	CHECKED			
	APPROVALS			SIZE SCALE : mm 1 : 1
				DRAWING NO. 000532
				REV. A
				ID NO. XXXXXXXXXX
				SHEET 1 OF 1

DESCRIPTION

NO	4	3	2	1
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